4-24-00

Company Sales Network HOME News & Events Site Map

Data Conversion

HOME
- Standard Products
- Microprocessors

Data Conversion

Non volatile memories

APPLICATIONS:

- **Instrumentation**: DSO, ATE, high-speed data acquisition, high energy physics, direct signal synthesis, signal analysis.
- **Digital transceiver**: radar, counter measures, EW missiles, satellites, jammer.
- Wireless communication: for high IF, broadband digital transceivers in satellite and ground equipments.
- Radiation tolerant applications: cumulative total dose >150 Krad (Si) measured.

TECHNOLOGIES:

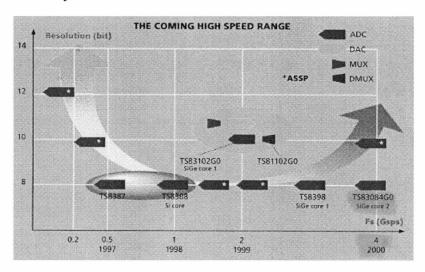
- Based on strategic alliances with major semiconductor companies (ST-Microelectronics, Siemens), TCS is offering the adequate technology from high speed bipolar to low power BiCMOS.
- Radiation tolerant oriented design for space

Lata conversion product

environment.

▶ The TCS ASSP* approach : G'core family

- TCS is introducing 3 successive generations of monolithic A/D Converter cores.
 - ADC 8bit 1 Gsps
 - ADC 8/10bit 2 Gsps
 - ADC 8/10bit 4 Gsps
- These cores could be interleaved in order to increase sampling frequency respectively to 4 and 8 and 16 Gsps.
- The characterzed and available TS 8388: (ADC 8 bit 1Gsps and 2GHz bandwidth) monolithic architecture core including S/H stages allows to consider an ASSP* approach on customer or application request. Some examples are shown on the drawing such as lower speed and higher resolution devices. In addition to these cores A/D Converters family, TCS is introducting associated devices such as D/A Converters, MUX and DMUX devices, amplifier, I/Q generation... in a monolithic way or not.



■ TCS strategy is to better serve the **G'core** customers with a complete offer of packaging and screening (from commercial plastic up to military and space levels.

*ASSP: Application Specific Standard Product.

see TS 8388 page, see FAQs page

ADC SELECTION GUIDE:

Power supply: $\pm 5 \text{ V}$

Product		Reso lution (#bit)	Sampling rate (Msps)	Input bandwidth (MHz)	Package	ENOB (#bits)	SFDR (DBe)	@Test conditions		Power	E
								Fin(MHz)	Fs(Msps)	dissipation	
JTS 8388 B	罗	8	1000	2000	DIE	7.2	56	500	1000	3.6 W	T§
TS 8388 B	Z	8	1000	1500	CQFP68	7.0	52	500	1000	3.6 W	TS
TS 8388 BG	Z	8	1000	1800	CBGA72 body15x15	7.0	52			3.6 W	
<u>TS 8387</u>	Z	8	500	1200	CQFP68	7.4	58	250	500	3.0 W	<u>TS</u>

For any further information about ADC, just click for a personalized contact!

DMUX SELECTION GUIDE:

Power supply: ± 5 V

Product		Max input sampling-rate (Msps)		Input data-format	Max output data-format (#bits)		Power dissipati
TS81102G0	8-10	2000	1:8 / 1:4	ECL diff.	8 ports of 10bit	TBGA240	3.8 to 5.8

For any further information about DMUX, just click for a personalized contact!

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Company Overview | Sales Network | News | Exhibitions | Jobs | Site Map

Microprocessors | Data Conversion | Memories |

TS8388B | FAQs

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